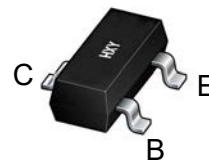


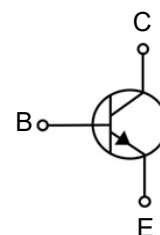


Features

IC = 2A Continuous Collector Current
350mW Power Dissipation



SOT-23



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
FMMT619TA	SOT-23	619	3000

Maxmim Ratings (Ta=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	50	V
V _{CEO}	Collector-Emitter Voltage	50	V
V _{EBO}	Emitter-Base Voltage	5	V
I _C	Collector Current -Continuous	2	A
P _C	Power Dissipation	0.35	W
R _{θJA}	Thermal Resistance from Junction to Ambient	357	°C/W
P _{CM}	Maximum Power Dissipation (note 1)	0.625	W
R _{θJA}	Thermal Resistance from Junction to Ambient (note 1)	200	°C/W
T _J , T _{stg}	Operation Junction and Storage Temperature Range	-55~+150	°C



Electrical Characteristics (Ta=25°C unless otherwise specified)

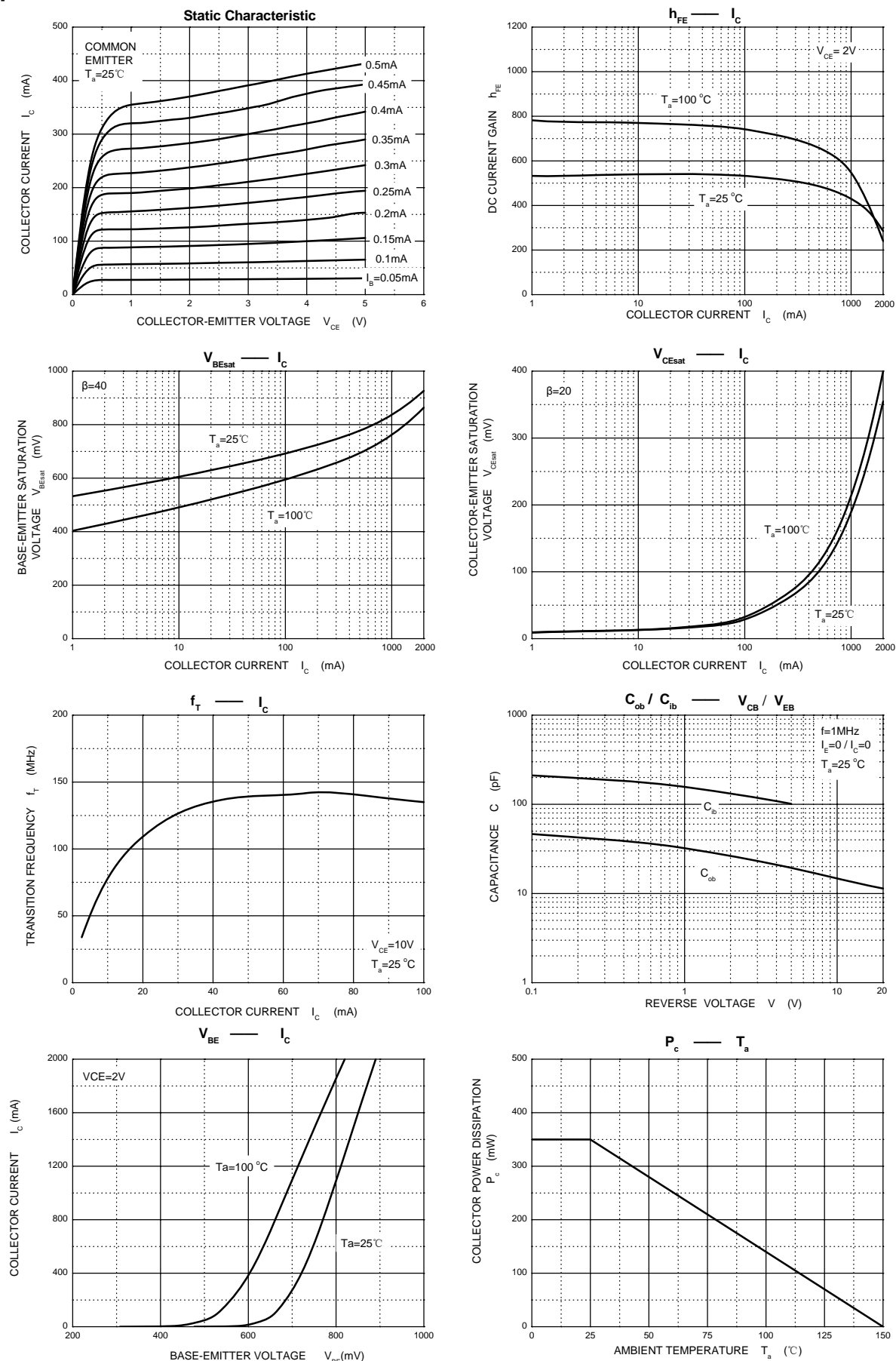
Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	$I_C=100\mu A, I_E=0$	50			V
Collector-emitter breakdown voltage (note 2)	$V_{(BR)CEO}$	$I_C=10mA, I_B=0$	50			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	$I_E=100\mu A, I_C=0$	5			V
Collector cut-off current	I_{CBO}	$V_{CB}=40V, I_E=0$			100	nA
Emitter cut-off current	I_{EBO}	$V_{EB}=4V, I_C=0$			100	nA
DC current gain (note 2)	$h_{FE(1)}$	$V_{CE}=2V, I_C=10mA$	200			
	$h_{FE(2)}$	$V_{CE}=2V, I_C=0.2A$	300			
	$h_{FE(3)}$	$V_{CE}=2V, I_C=1A$	200			
	$h_{FE(4)}$	$V_{CE}=2V, I_C=2A$	100			
	$h_{FE(5)}$	$V_{CE}=2V, I_C=6A$		40		
Collector-emitter saturation voltage (note 2)	$V_{CE(sat)1}$	$I_C=0.1A, I_B=10mA$			20	mV
	$V_{CE(sat)2}$	$I_C=1A, I_B=10mA$			200	mV
	$V_{CE(sat)3}$	$I_C=2A, I_B=100mA$			220	mV
Base-emitter saturation voltage (note 2)	$V_{BE(sat)}$	$I_C=2A, I_B=50mA$			1	V
Base-emitter on voltage (note 2)	$V_{BE(on)}$	$I_C=2A, V_{CE}=2V$			1	V
Output capacitance	C_{ob}	$V_{CB}=10V, f=1MHz$			20	pF
Turn-on time	$t_{(on)}$	$V_{CC}=10V, I_C=1A, I_{B1}=-I_{B2}=10mA$		170		ns
Turn-off time	$t_{(off)}$			750		ns
Transition frequency	f_T	$V_{CE}=10V, I_C=50mA, f=100MHz$	100			MHz

Notes :

- 1.Maximum power dissipation is calculated assuming that the device is mounted on a ceramic substrate measuring 15x15x0.6mm.
2. Pulse test: Pulse width $\leq 300\mu s$, duty cycle $\leq 2.0\%$.

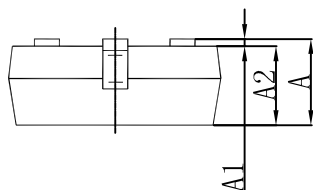
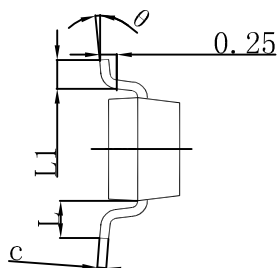
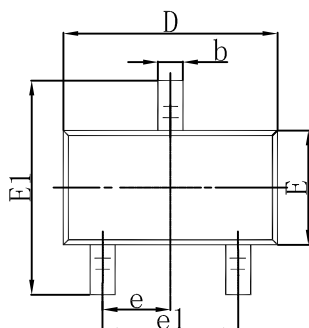


Typical Characteristics





SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°



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